

PINNING :
 ① Pin : RF INPUT
 ② Vcc1 : 1st. DC SUPPLY
 ③ Vcc2 : FINAL DC SUPPLY
 ④ Po : RF OUTPUT
 ⑤ GND : FIN

ABSOLUTE MAXIMUM RATINGS (Tc = 25°C unless otherwise noted)

| Symbol | Parameter | Conditions | Ratings | Unit |
|----------|----------------------------|------------------------------|-------------|------|
| Vcc | Supply voltage | | 17 | V |
| Icc | Total current | | 5 | A |
| Pin(max) | Input power | Vcc1 ≤ 12.5V, ZG = ZL = 50 Ω | 0.4 | W |
| Po(max) | Output power | Same as above | 20 | W |
| Tc(OP) | Operation case temperature | Same as above | - 30 to 110 | °C |
| Tstg | Storage temperature | | - 40 to 110 | °C |

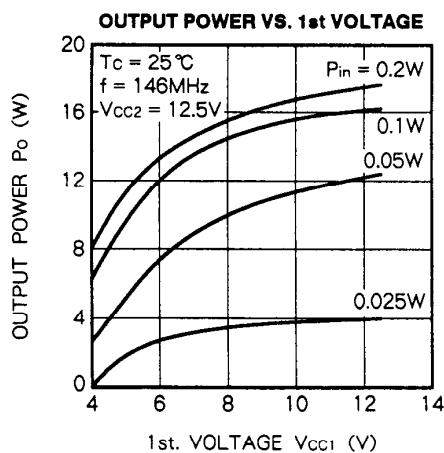
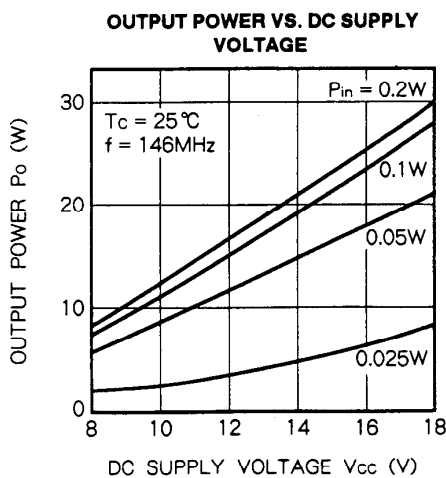
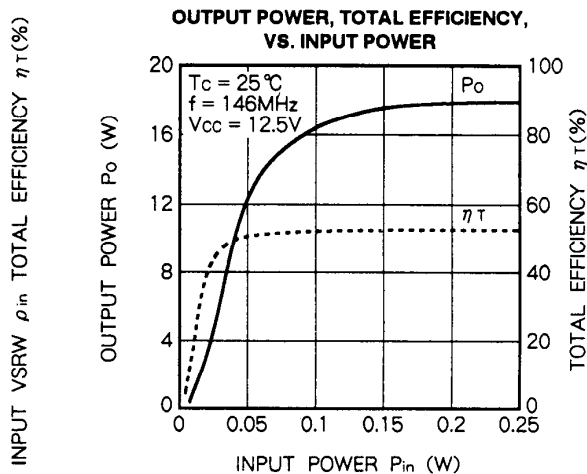
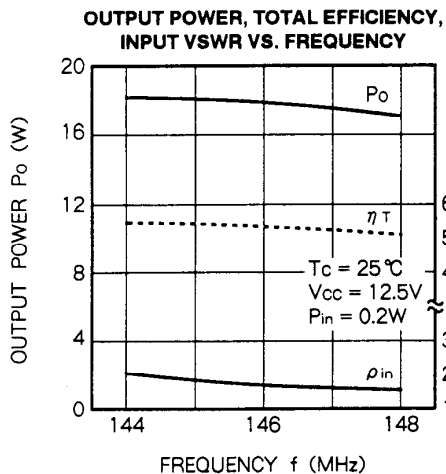
Note. Above parameters are guaranteed independently.

ELECTRICAL CHARACTERISTICS (Tc = 25°C unless otherwise noted)

| Symbol | Parameter | Test conditions | Limits | | Unit |
|--------|---------------------|------------------------------------------------------------------------------------|---------------------------|------|------|
| | | | Min | Max | |
| f | Frequency range | Pin = 0.2W Vcc = 12.5V ZG = ZL = 50 Ω | 144 | 148 | MHz |
| Po | Output power | | 13 | | W |
| ητ | Total efficiency | | 48 | | % |
| 2fo | 2nd. harmonic | | | - 25 | dBc |
| 3fo | 3rd. harmonic | | | - 35 | dBc |
| ρin | Input VSWR | | | 2.8 | - |
| - | Load VSWR tolerance | Vcc = 15.2V Po = 14W (Pin : controlled) ρL = 20 : 1 (All phase) ZG = 50 Ω | No degradation or destroy | | - |

Note. Above parameters, ratings, limits and conditions are subject to change.

TYPICAL PERFORMANCE DATA



DESIGN CONSIDERATION OF HEAT RADIATION

Please refer to following consideration when designing heat sink.

1. Junction temperature of incorporated transistors at standard operation.

(1) Thermal resistance between junction and package of incorporated transistors.

a) First stage transistor
 $R_{th(j-c)1} = 10\text{ }^{\circ}\text{C/W(Typ.)}$

b) Final stage transistor
 $R_{th(j-c)2} = 3\text{ }^{\circ}\text{C/W(Typ.)}$

(2) Junction temperature of incorporated transistors at standard operation.

- Conditions for standard operation.

$P_o = 13\text{W}$, $V_{cc} = 12.5\text{V}$, $P_{in} = 0.2\text{W}$, $\eta T = 48\%$ (minimum rating). $P_{o1}(\text{Note1}) = 2.5\text{W}$, $I_T = 2.2\text{A}(I_{T1}(\text{2}) = 0.45\text{A}$, $I_{T2}(\text{3}) = 1.75\text{A}$)

Note1 : Output power of the first stage transistor

Note2 : Circuit current of the first stage transistor

Note3 : Circuit current of the first stage transistor

- Junction temperature of the first stage transistor

$$\begin{aligned} T_{j1} &= (V_{cc} \times I_{T1} - P_{o1} + P_{in}) \times R_{th(j-c)1} + T_c(\text{4}) \\ &= (12.5 \times 0.45 - 2.5 + 0.2) \times 10 + T_c \\ &= 33 + T_c(\text{ }^{\circ}\text{C}) \end{aligned}$$

Note4 : Package temperature of device

- Junction temperature of the final stage transistor

$$\begin{aligned} T_{j2} &= (V_{cc} \times I_{T2} - P_o + P_{o1}) \times R_{th(j-c)2} + T_c \\ &= (12.5 \times 1.75 - 13 + 2.5) \times 3 + T_c \\ &= 34 + T_c(\text{ }^{\circ}\text{C}) \end{aligned}$$

2. Heat sink design

In thermal design of heat sink, try to keep the package temperature at the upper limit of the operating ambient temperature (normally $T_a = 60\text{ }^{\circ}\text{C}$) and at the output power of 13W below $90\text{ }^{\circ}\text{C}$.

The thermal resistance $R_{th(c-a)}(\text{5})$ of the heat sink to realize this :

$$\begin{aligned} R_{th(c-a)} &= \frac{T_c - T_a}{(P_o / \eta T) - P_o + P_{in}} = \frac{90 - 60}{(13 / 0.48) - 13 + 0.2} \\ &= 2.8(\text{ }^{\circ}\text{C/W}) \end{aligned}$$

Note5 : Inclusive of the contact thermal resistance between device and heat sink

Mounting the heat sink of the above thermal resistance on the device,

$$T_{j1} = 113\text{ }^{\circ}\text{C}, T_{j2} = 134\text{ }^{\circ}\text{C} \text{ at } T_a = 60\text{ }^{\circ}\text{C}, T_c = 90\text{ }^{\circ}\text{C},$$

In the annual average of ambient temperature is $30\text{ }^{\circ}\text{C}$,

$$T_{j1} = 103\text{ }^{\circ}\text{C}, T_{j2} = 104\text{ }^{\circ}\text{C}$$

As the maximum junction temperature of these incorporated transistors T_{jmax} are $175\text{ }^{\circ}\text{C}$, application under fully derated condition is ensured.